

STP60NF06

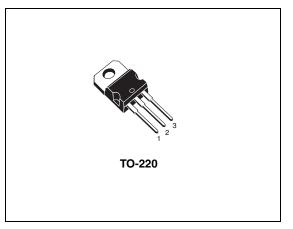
General features

Туре	V _{DSS}	R _{DS(on)}	I _D
STP60NF06	60V	<0.016Ω	60A

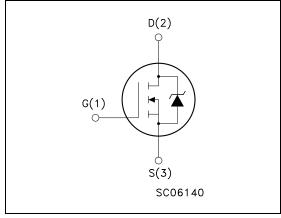
- Exceptional dv/dt capability
- 100% avalanche tested
- Application oriented characterization

Description

This Power MOSFET series realized with STMicroelectronics unique STripFET process has specifically been designed to minimize input capacitance and gate charge. It is therefore suitable as primary switch in advanced highefficiency isolated DC-DC converters for Telecom and Computer application. It is also intended for any application with low gate charge drive requirements.



Internal schematic diagram



Applications

Switching application

Order code

Part number	nber Marking Package		Packaging
STP60NF06	P60NF06	TO-220	Tube

Contents

1	Electrical ratings
2	Electrical characteristics4
	2.1 Electrical characteristics (curves) 6
3	Test circuit
4	Package mechanical data9
5	Revision history



1 Electrical ratings

Table 1.	Absolute maximum ratings		
Symbol	Parameter	Value	Unit
V _{DS}	Drain-source voltage (V _{GS} = 0)	60	V
V _{GS}	Gate- source voltage	±20	V
Ι _D	Drain current (continuos) at $T_C = 25^{\circ}C$	60	Α
I _D	Drain current (continuos) at T _C = 100°C	42	А
I _{DM} ⁽¹⁾	Drain current (pulsed)	240	А
P _{TOT}	Total dissipation at $T_{C} = 25^{\circ}C$	110	
	Derating factor	0.74	W/°C
dv/dt (2)	⁾ Peak diode recovery voltage slope 7.5		V/ns
T _{stg}	Storage temperature	- 55 to 175	
Тj	Max. operating junction temperature	- 55 10 175	°C

Table 1. Absolute maximum ratings

1. Pulse width limited by safe operating area

2. $I_{SD} \leq 60A$, di/dt $\leq 400 A/\mu s$, $V_{DD} \leq 48V$, $Tj \leq T_{jmax}$

Table 2. Thermal data

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case max	1.36	°C/W
R _{thj-a}	Thermal resistance junction-ambient max	62.5	°C/W
TI	Maximum lead temperature for soldering purpose	300	°C

Table 3. Avalanche characteristics

Symbol	Parameter	Value	Unit
I _{AR}	Avalanche current, repetitive or not-repetitive (pulse width limited by Tj Max)	30	А
E _{AS}	Single pulse avalanche energy (starting Tj=25°C, Id=lar, Vdd=30V)	370	mJ

57

2 Electrical characteristics

(T_{CASE}=25°C unless otherwise specified)

Table 4.	Un/on states					
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source Breakdown voltage	I _D = 250 μA, V _{GS} = 0	60			V
I _{DSS}	Zero gate voltage Drain current (V _{GS} = 0)	V _{DS} = Max rating V _{DS} =Max rating, T _C =125°C			1 10	μΑ μΑ
I _{GSS}	Gate-body leakage current (V _{DS} = 0)	$V_{GS} = \pm 20V$			±100	nA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}, I_D = 250 \mu A$	2		4	V
R _{DS(on)}	Static drain-source on resistance	V _{GS} = 10V, I _D = 30A		0.014	0.016	Ω

Table 4. On/off states

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
9 _{fs} ⁽¹⁾	Forward transconductance	V _{DS} = 15V _, I _D =30A		50		S
C _{iss}	Input capacitance			1660		pF
C _{oss}	Output capacitance	V _{DS} = 25V, f = 1 MHz,		400		pF
C _{rss}	Reverse transfer capacitance	V _{GS} = 0		140		pF
Qg	Total gate charge	V _{DD} = 30V, I _D = 60A,		54	73	nC
Q _{gs}	Gate-source charge	V _{GS} = 10V		9		nC
Q _{gd}	Gate-drain charge	(see Figure 12)		23		nC

1. Pulsed: Pulse duration = 300 μ s, duty cycle 1.5%

Table 6. Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)} t _r	Turn-on delay time Rise time			15 65		ns ns
t _{d(off)} t _f	Turn-off-delay time Fall time	$\begin{split} V_{DD} &= 30V, \ I_D = 30A, \\ R_G &= 4.7\Omega, \ V_{GS} = 10V \\ (see \ Figure \ 11) \end{split}$		45 20		ns ns

Tuble 7.						
Symbol	Parameter	Test conditions	Min	Тур.	Max	Unit
I _{SD}	Source-drain current				60	А
$I_{SDM}^{(1)}$	Source-drain current (pulsed)				240	А
V _{SD} ⁽²⁾	Forward on voltage	$I_{SD} = 60A, V_{GS} = 0$			1.3	V
t _{rr}	Reverse recovery time	I _{SD} = 60A, V _{DD} =30V		70		ns
Q _{rr}	Reverse recovery charge	di/dt = 100A/µs, Tj = 150°C		185		nC
I _{RRM}	Reverse recovery current	(see Figure 13)		5		А

Table 7. Source drain diode

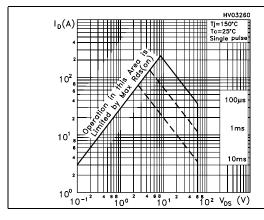
1. Pulse width limited by safe operating area.

2. Pulsed: Pulse duration = 300 μ s, duty cycle 1.5%



2.1 Electrical characteristics (curves)

Figure 1. Safe operating area





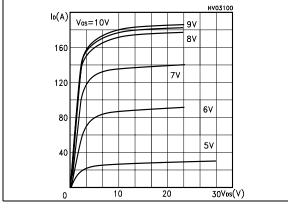
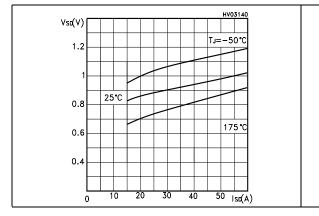


Figure 5. Source-drain diode forward characteristics





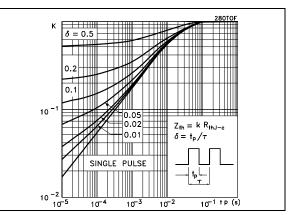


Figure 4. Transfer characteristics

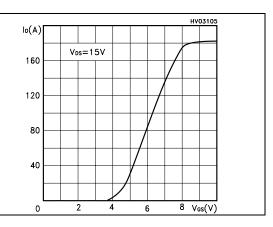
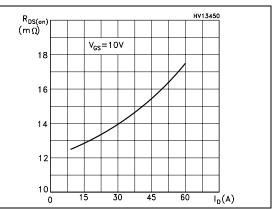
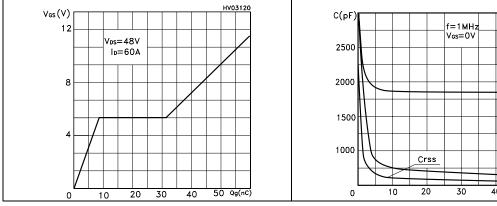


Figure 6. Static drain-source on resistance

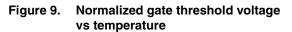


HV03125

Ciss



Gate charge vs gate-source voltage Figure 8. Capacitance variations Figure 7.



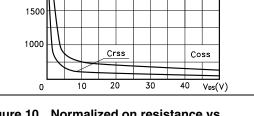
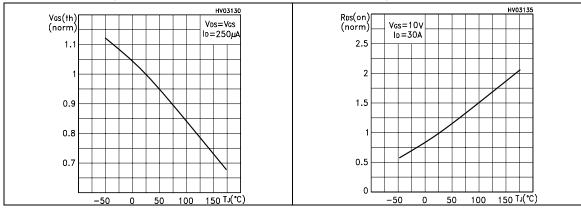


Figure 10. Normalized on resistance vs temperature



57

3 Test circuit

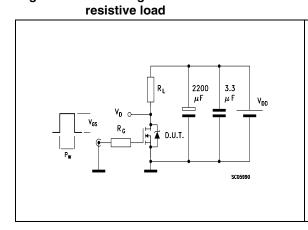
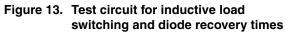


Figure 11. Switching times test circuit for



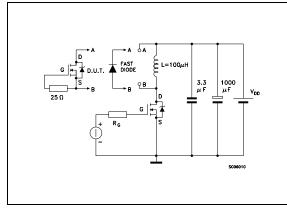




Figure 16. Switching time waveform

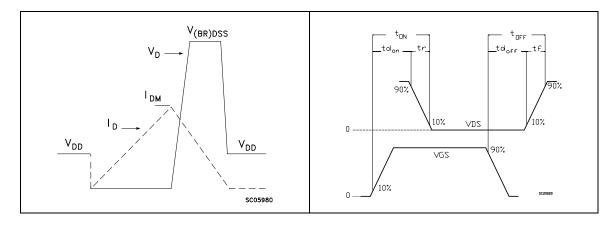


Figure 12. Gate charge test circuit

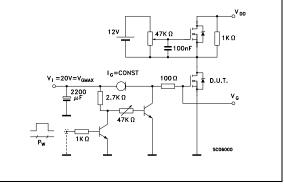
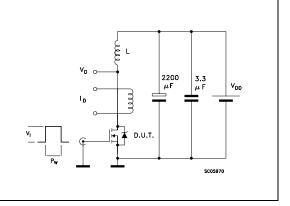


Figure 14. Unclamped Inductive load test circuit





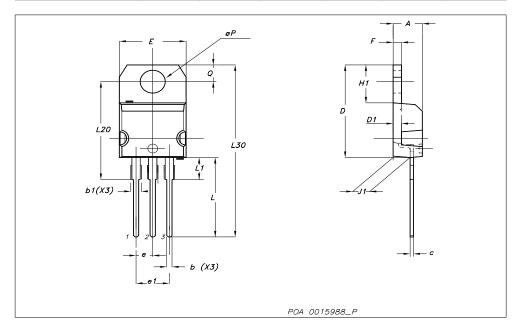
4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: *www.st.com*



Dim		mm			inch	
Dim	Min	Тур	Мах	Min	Тур	Max
A	4.40		4.60	0.173		0.181
b	0.61		0.88	0.024		0.034
b1	1.14		1.70	0.044		0.066
С	0.49		0.70	0.019		0.027
D	15.25		15.75	0.6		0.62
D1		1.27			0.050	
E	10		10.40	0.393		0.409
е	2.40		2.70	0.094		0.106
e1	4.95		5.15	0.194		0.202
F	1.23		1.32	0.048		0.051
H1	6.20		6.60	0.244		0.256
J1	2.40		2.72	0.094		0.107
L	13		14	0.511		0.551
L1	3.50		3.93	0.137		0.154
L20		16.40			0.645	
L30		28.90			1.137	
θΡ	3.75		3.85	0.147		0.151
Q	2.65		2.95	0.104		0.116







5 Revision history

Table 8. Revision history

Date	Revision	Changes
09-Sep-2004	3	Complete version
17-Aug-2006	4	The document has been reformatted
04-Oct-2006	5	Changes in <i>Dynamic</i>
02-Mar-2007	6	Safe operating area has been updated



Please Read Carefully:

Information in this document is provided solely in connection with ST products. STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, modifications or improvements, to this document, and the products and services described herein at any time, without notice.

All ST products are sold pursuant to ST's terms and conditions of sale.

Purchasers are solely responsible for the choice, selection and use of the ST products and services described herein, and ST assumes no liability whatsoever relating to the choice, selection or use of the ST products and services described herein.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted under this document. If any part of this document refers to any third party products or services it shall not be deemed a license grant by ST for the use of such third party products or services, or any intellectual property contained therein or considered as a warranty covering the use in any manner whatsoever of such third party products or services or services or any intellectual property contained therein.

UNLESS OTHERWISE SET FORTH IN ST'S TERMS AND CONDITIONS OF SALE ST DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY WITH RESPECT TO THE USE AND/OR SALE OF ST PRODUCTS INCLUDING WITHOUT LIMITATION IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION), OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.

UNLESS EXPRESSLY APPROVED IN WRITING BY AN AUTHORIZED ST REPRESENTATIVE, ST PRODUCTS ARE NOT RECOMMENDED, AUTHORIZED OR WARRANTED FOR USE IN MILITARY, AIR CRAFT, SPACE, LIFE SAVING, OR LIFE SUSTAINING APPLICATIONS, NOR IN PRODUCTS OR SYSTEMS WHERE FAILURE OR MALFUNCTION MAY RESULT IN PERSONAL INJURY, DEATH, OR SEVERE PROPERTY OR ENVIRONMENTAL DAMAGE. ST PRODUCTS WHICH ARE NOT SPECIFIED AS "AUTOMOTIVE GRADE" MAY ONLY BE USED IN AUTOMOTIVE APPLICATIONS AT USER'S OWN RISK.

Resale of ST products with provisions different from the statements and/or technical features set forth in this document shall immediately void any warranty granted by ST for the ST product or service described herein and shall not create or extend in any manner whatsoever, any liability of ST.

ST and the ST logo are trademarks or registered trademarks of ST in various countries.

Information in this document supersedes and replaces all information previously supplied.

The ST logo is a registered trademark of STMicroelectronics. All other names are the property of their respective owners.

© 2007 STMicroelectronics - All rights reserved

STMicroelectronics group of companies

Australia - Belgium - Brazil - Canada - China - Czech Republic - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan -Malaysia - Malta - Morocco - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States of America

www.st.com

12/12

57